

- ★ 100% EAS Guaranteed
- ★ Green Device Available
- ★ Super Low Gate Charge
- ★ Excellent CdV/dt effect decline
- ★ Advanced high cell density Trench technology

Product Summary



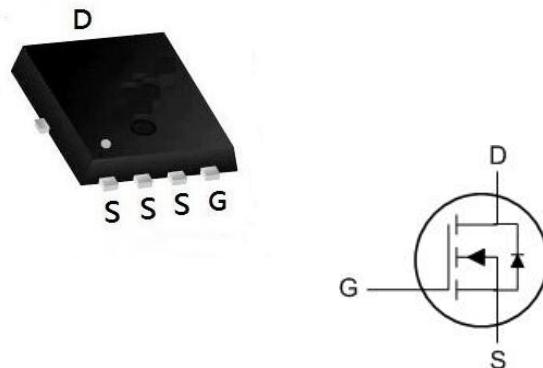
| BVDSS | RDS(ON) | ID |
|-------|---------|-----|
| 30V | 4.7mΩ | 60A |

Description

The XXW60N03D is the high cell density trenched N-ch MOSFETs, which provide excellent RDS(ON) and gate charge for most of the synchronous buck converter applications.

The XXW60N03D meet the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

PDFN3333-8L Pin Configuration



Absolute Maximum Ratings

| Symbol | Parameter | Rating | Units |
|---------------------------------------|--|------------|-------|
| V _{DS} | Drain-Source Voltage | 30 | V |
| V _{GS} | Gate-Source Voltage | ±20 | V |
| I _D @T _C =25°C | Continuous Drain Current, V _{GS} @ 10V ¹ | 60 | A |
| I _D @T _C =100°C | Continuous Drain Current, V _{GS} @ 10V ¹ | 30 | A |
| I _{DM} | Pulsed Drain Current ² | 160 | A |
| EAS | Single Pulse Avalanche Energy ³ | 58 | mJ |
| I _{AS} | Avalanche Current | 60 | A |
| P _D @T _C =25°C | Total Power Dissipation ⁴ | 25 | W |
| T _{STG} | Storage Temperature Range | -55 to 150 | °C |
| T _J | Operating Junction Temperature Range | -55 to 150 | °C |

Thermal Data

| Symbol | Parameter | Typ. | Max. | Unit |
|------------------|--|------|------|------|
| R _{θJA} | Thermal Resistance Junction-Ambient ¹ | --- | 62 | °C/W |

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|----------------------------|--|--|------|------|-----------|------------------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{\text{GS}}=0\text{V}$, $I_{\text{D}}=250\mu\text{A}$ | 30 | --- | --- | V |
| $\text{R}_{\text{DS(ON)}}$ | Static Drain-Source On-Resistance ² | $V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=20\text{A}$ | --- | 4.7 | 6.0 | $\text{m}\Omega$ |
| | | $V_{\text{GS}}=4.5\text{V}$, $I_{\text{D}}=10\text{A}$ | --- | 6.5 | 9 | |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage | $V_{\text{GS}}=V_{\text{DS}}$, $I_{\text{D}}=250\mu\text{A}$ | 1.2 | --- | 2.5 | V |
| I_{DSS} | Drain-Source Leakage Current | $V_{\text{DS}}=24\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$ | --- | --- | 1 | uA |
| | | $V_{\text{DS}}=24\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=55^\circ\text{C}$ | --- | --- | 5 | |
| I_{GSS} | Gate-Source Leakage Current | $V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$ | --- | --- | ± 100 | nA |
| g_{fs} | Forward Transconductance | $V_{\text{DS}}=5\text{V}$, $I_{\text{D}}=30\text{A}$ | --- | 43 | --- | S |
| R_g | Gate Resistance | $V_{\text{DS}}=0\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$ | --- | 1.7 | --- | Ω |
| Q_g | Total Gate Charge (4.5V) | $V_{\text{DS}}=15\text{V}$, $V_{\text{GS}}=4.5\text{V}$, $I_{\text{D}}=15\text{A}$ | --- | 34 | --- | nC |
| Q_{gs} | Gate-Source Charge | | --- | 6 | --- | |
| Q_{gd} | Gate-Drain Charge | | --- | 9 | --- | |
| $T_{\text{d(on)}}$ | Turn-On Delay Time | $V_{\text{DD}}=15\text{V}$, $V_{\text{GS}}=10\text{V}$, $R_g=3.3\Omega$ | --- | 8.5 | --- | ns |
| T_r | Rise Time | | --- | 103 | --- | |
| $T_{\text{d(off)}}$ | Turn-Off Delay Time | | --- | 37.3 | --- | |
| T_f | Fall Time | | --- | 105 | --- | |
| C_{iss} | Input Capacitance | $V_{\text{DS}}=15\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$ | --- | 1600 | --- | pF |
| C_{oss} | Output Capacitance | | --- | 245 | --- | |
| C_{rss} | Reverse Transfer Capacitance | | --- | 215 | --- | |

Diode Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|-----------------|--|--|------|------|------|------|
| I_s | Continuous Source Current ^{1,6} | $V_{\text{G}}=V_{\text{D}}=0\text{V}$, Force Current | --- | --- | 60 | A |
| I_{SM} | Pulsed Source Current ^{2,6} | | --- | --- | 140 | A |
| V_{SD} | Diode Forward Voltage ² | $V_{\text{GS}}=0\text{V}$, $I_s=1\text{A}$, $T_J=25^\circ\text{C}$ | --- | --- | 1 | V |

Note :

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
- 3.The EAS data shows Max. rating . The test condition is $V_{\text{DD}}=25\text{V}$, $V_{\text{GS}}=10\text{V}$, $L=0.1\text{mH}$, $I_{\text{AS}}=48\text{A}$
- 4.The power dissipation is limited by 150°C junction temperature
- 5.The data is theoretically the same as I_{D} and I_{DM} , in real applications , should be limited by total power dissipation.

Typical Performance Characteristics

Figure 1: Output Characteristics

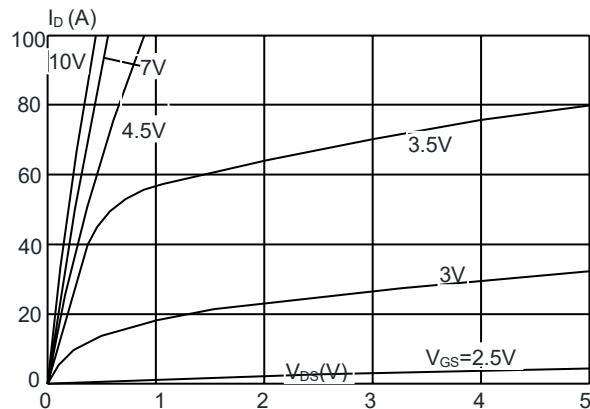


Figure 3: On-resistance vs. Drain Current

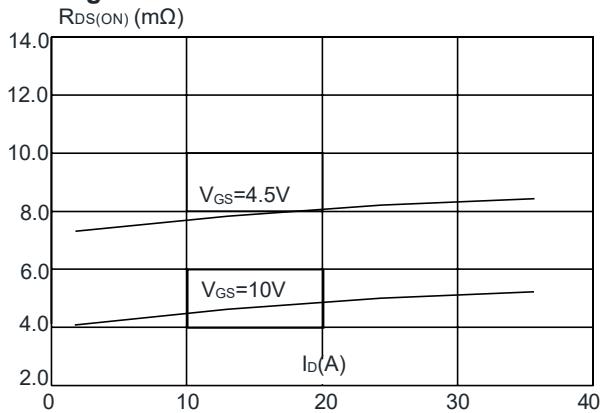


Figure 5: Gate Charge Characteristics

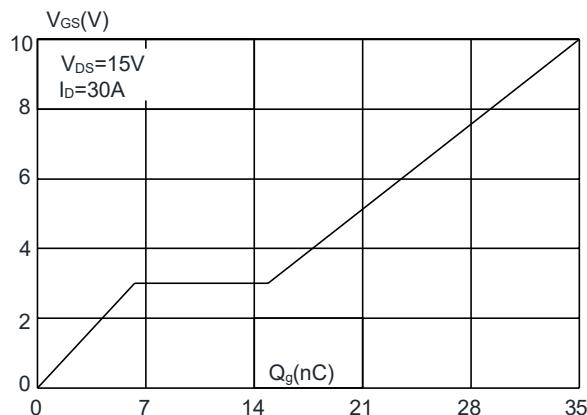


Figure 2: Typical Transfer Characteristics

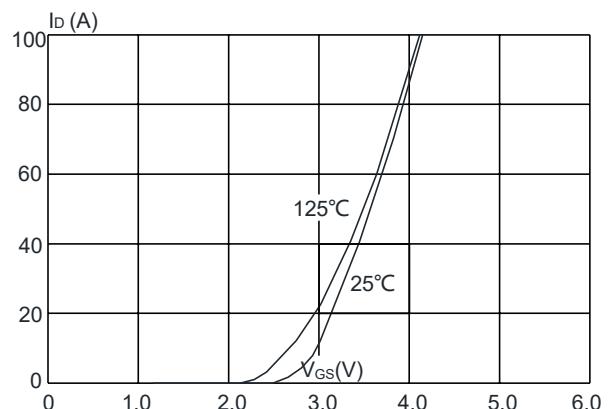


Figure 4: Body Diode Characteristics

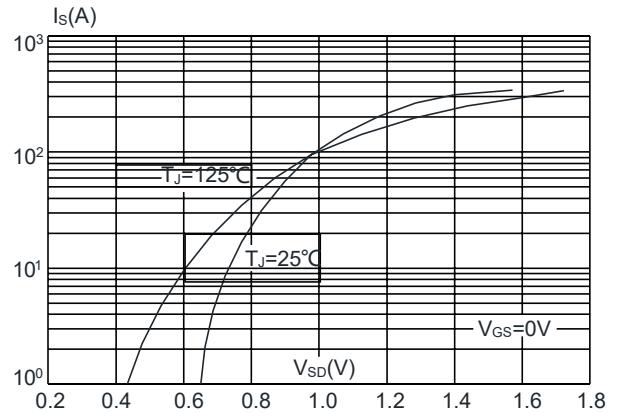
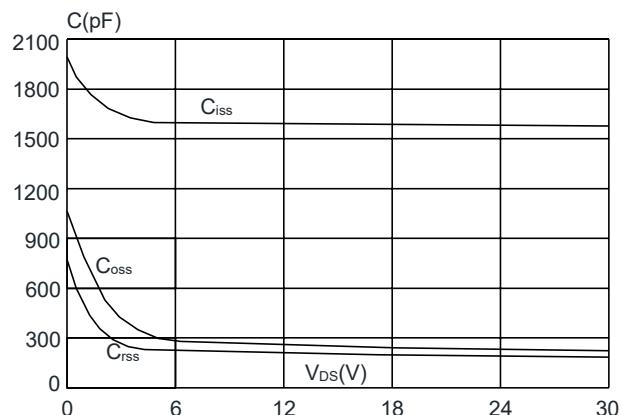


Figure 6: Capacitance Characteristics



N-Ch 30V Fast Switching MOSFETs

Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

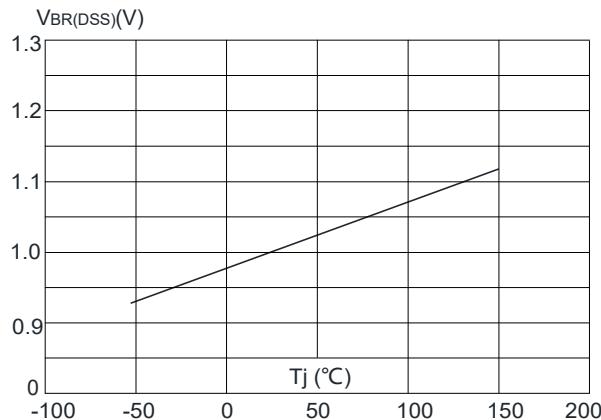


Figure 9: Maximum Safe Operating Area

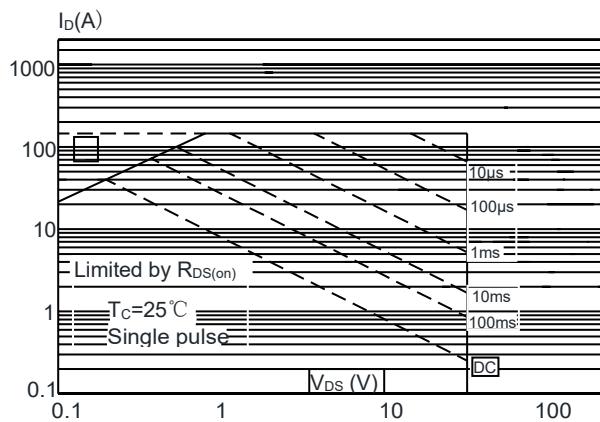


Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

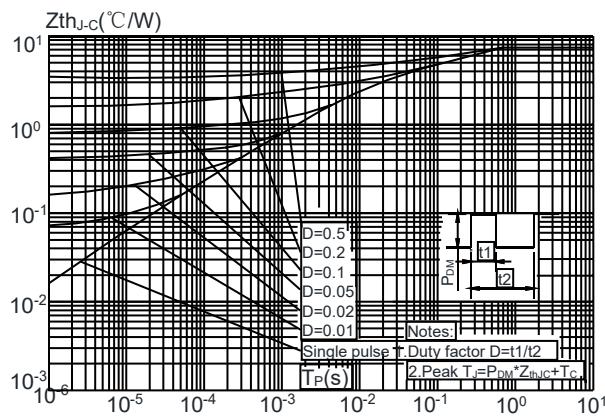


Figure 8: Normalized on Resistance vs. Junction Temperature

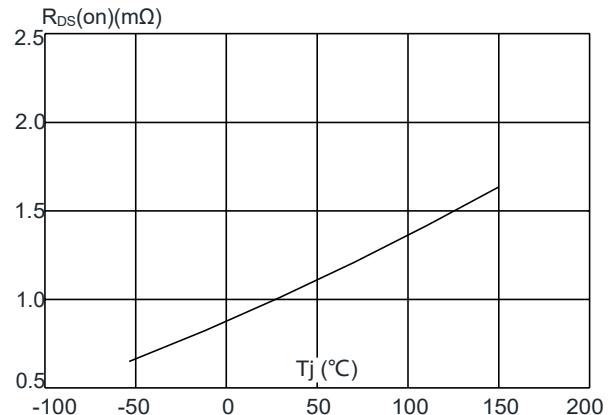
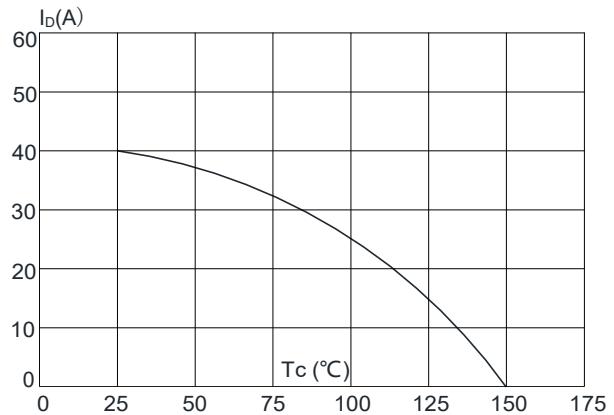


Figure 10: Maximum Continuous Drain Current vs. Case Temperature



Test Circuit

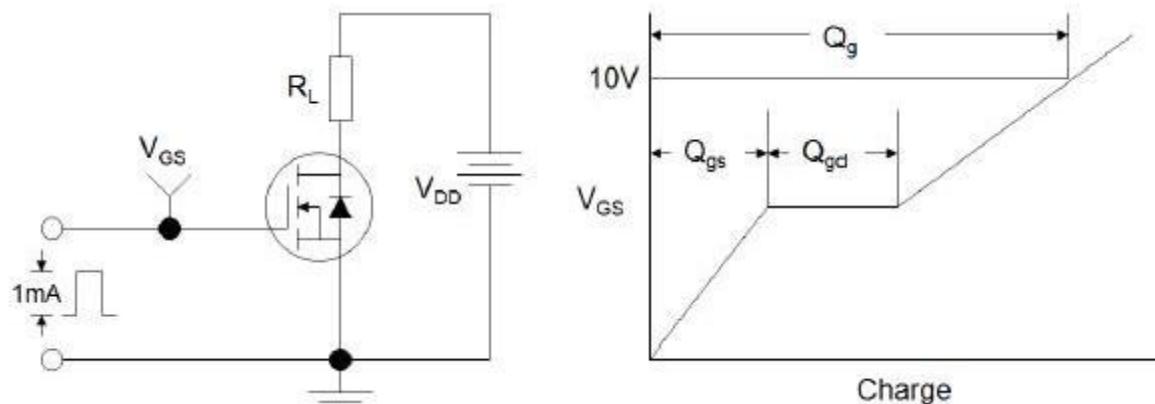


Figure 1: Gate Charge Test Circuit & Waveform

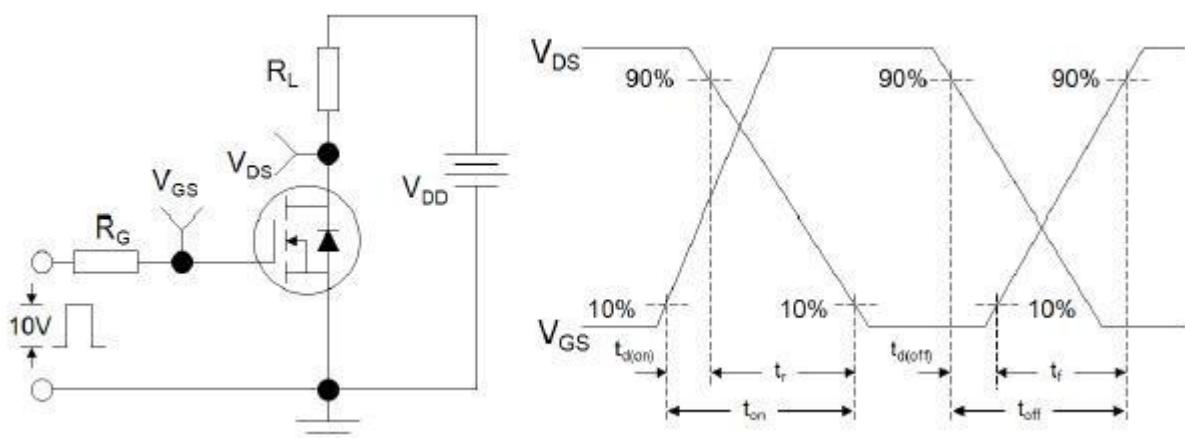


Figure 2: Resistive Switching Test Circuit & Waveforms

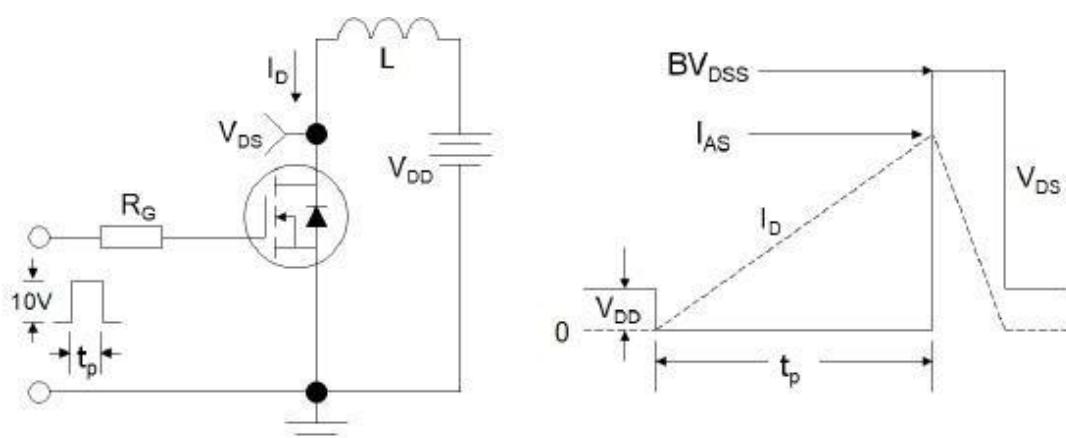
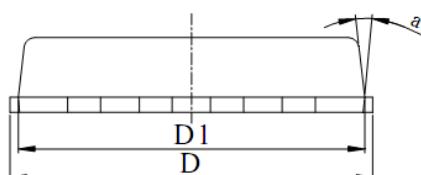
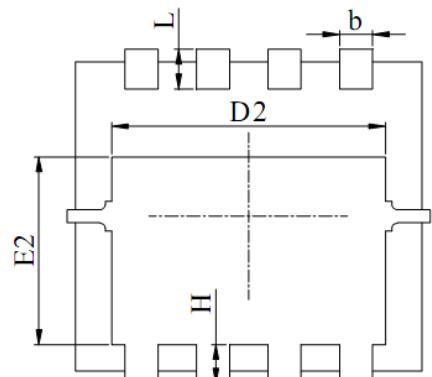
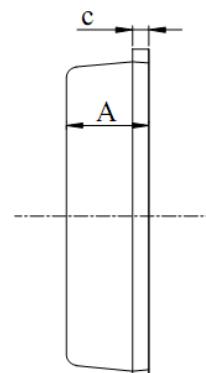
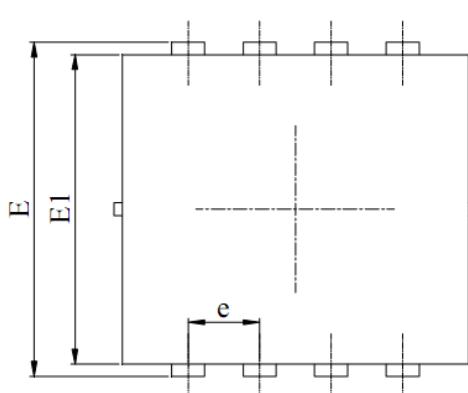


Figure 3: Unclamped Inductive Switching Test Circuit & Waveforms

Package Mechanical Data-PDFN3333-8L-Single


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M,1994.
2. ALL DIMNESIONS IN MILLIMETER (ANGLE IN DEGREE).
3. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS OR GATE BURRS.

| DIM. | MILLIMETER | | |
|------|------------|------|------|
| | MIN. | NOM. | MAX. |
| A | 0.70 | 0.75 | 0.80 |
| b | 0.25 | 0.30 | 0.35 |
| c | 0.10 | 0.20 | 0.25 |
| D | 3.00 | 3.15 | 3.25 |
| D1 | 2.95 | 3.05 | 3.15 |
| D2 | 2.39 | 2.49 | 2.59 |
| E | 3.20 | 3.30 | 3.40 |
| E1 | 2.95 | 3.05 | 3.15 |
| E2 | 1.70 | 1.80 | 1.90 |
| e | 0.65 BSC | | |
| H | 0.30 | 0.40 | 0.50 |
| L | 0.25 | 0.40 | 0.50 |
| a | --- | --- | 15° |

